



DMN65D8LQ

### N-CHANNEL ENHANCEMENT MODE MOSFET

# **Product Summary**

| V <sub>(BR)DSS</sub> | R <sub>DS(ON)</sub>        | Package | I <sub>D</sub><br>T <sub>A</sub> = +25°C |  |
|----------------------|----------------------------|---------|--|--|
| 60V                  | 3Ω @ V <sub>GS</sub> = 10V | SOT23   | 310mA                                    |  |
| 607                  | 4Ω @ V <sub>GS</sub> = 5V  | 50123   | 270mA                                    |  |

## Description

This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>), yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

# Applications

- **DC-DC Converters**
- **Power Management Functions**
- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.

## **Features**

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Small Surface Mount Package
- **ESD** Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

## **Mechanical Data**

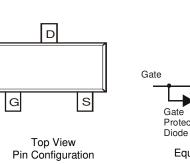
- Case: SOT23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating Matte Tin Finish Annealed over Alloy 42 Leadframe). (e3)
- Weight: 0.006 grams (Approximate)

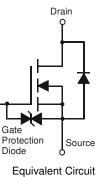
#### SOT23





Top View





## Ordering Information (Note 5)

| Part Number  | Case  | Packaging          |
|--------------|-------|--------------------|
| DMN65D8LQ-7  | SOT23 | 3,000/Tape & Reel  |
| DMN65D8LQ-13 | SOT23 | 10,000/Tape & Reel |

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

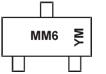
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product\_compliance\_definitions/.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.



## **Marking Information**



MM6 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011) M = Month (ex: 9 = September)

#### Date Code Kev

| Year  | 2011 |     | 2015 | 2016 | 201 | 17 2 | 018 | 2019 | 2020 | 2021 | 2022 | 2023 |
|-------|------|-----|------|------|-----|------|-----|------|------|------|------|------|
| Code  | Y    |     | С    | D    | E   |      | F   | G    | Н    | I    | J    | K    |
| Month | Jan  | Feb | Mar  | Apr  | May | Jun  | Jul | Aug  | Sep  | Oct  | Nov  | Dec  |
| Code  | 1    | 2   | 3    | 4    | 5   | 6    | 7   | 8    | 9    | 0    | N    | П    |

## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                                     | Symbol           | Value                                     | Units            |            |    |
|--|------------------|---|------------------|------------|----|
| Drain-Source Voltage                               | V <sub>DSS</sub> | 60  | V                |            |    |
| Gate-Source Voltage                                |                  |   | V <sub>GSS</sub> | ±20        | V  |
| Continuous Drain Current (Note 7) $V_{GS}$ = 10V   | Steady<br>State  | $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$ | ID               | 310<br>240 | mA |
| Continuous Drain Current (Note 7) $V_{GS} = 5V$    | Steady<br>State  | $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$ | ID               | 270<br>210 | mA |
| Pulsed Drain Current (10µs pulse, duty cycle = 1%) | I <sub>DM</sub>  | 800                                       | mA               |            |    |
| Maximum Body Diode Continuous Current (Note 6)     | ls               | 500                                       | mA               |            |    |

## **Thermal Characteristics**

| Characteristic                          |          | Symbol                           | Value       | Units |  |
|---|----------|----------------------------------|-------------|-------|--|
| Tatal Dower Dissinction                 | (Note 7) | P                                | 370         | mW    |  |
| Total Power Dissipation                 | (Note 6) | PD                               | 540         | IIIVV |  |
| Thermol Desistance, lunction to Ambient | (Note 7) | 5                                | 348         |       |  |
| Thermal Resistance, Junction to Ambient | (Note 6) | R <sub>0JA</sub>                 | 241         | °C/W  |  |
| Thermal Resistance, Junction to Case    | (Note 6) | R <sub>eJC</sub>                 | 91          |       |  |
| Operating and Storage Temperature Range |          | T <sub>J,</sub> T <sub>STG</sub> | -55 to +150 | °C    |  |

 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout.
Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided. Notes:



# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

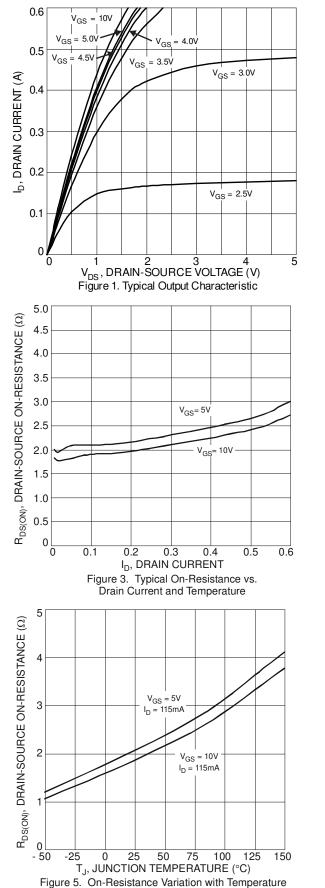
| Characteristic                           | Symbol              | Min   | Тур  | Max | Unit | Test Condition  |
|--|---------------------|-------|------|-----|------|---|
| OFF CHARACTERISTICS (Note 8)             | Oymbol              | WIIII | TYP  | Wax | onit |   |
| Drain-Source Breakdown Voltage           | BV <sub>DSS</sub>   | 60    |      |     | V    | $V_{GS} = 0V, I_D = 250 \mu A$  |
| Zero Gate Voltage Drain Current          | IDSS                | _     | _    | 1.0 | μA   | $V_{DS} = 60V, V_{GS} = 0V$   |
| Gate-Body Leakage                        | IGSS                | _     | _    | ±5  | μA   | $V_{GS} = \pm 20V, V_{DS} = 0V$   |
| ON CHARACTERISTICS (Note 8)              |                     |       |      |     |      |   |
| Gate Threshold Voltage                   | V <sub>GS(th)</sub> | 1.2   | _    | 2.0 | V    | $V_{DS} = V_{GS}, I_D = 250 \mu A$                                      |
| Static Drain-Source On-Resistance        |                     |       | 2    | 3   | Ω    | $V_{GS} = 10V, I_D = 0.115A$  |
| Static Drain-Source On-Resistance        | R <sub>DS(ON)</sub> | _     | 2.5  | 4   | Ω    | $V_{GS} = 5V, I_D = 0.115A$   |
| Forward Transconductance                 | <b>g</b> fs         | 80    | 290  |     | mS   | $V_{DS} = 10V, I_D = 0.115A$  |
| Diode Forward Voltage                    | V <sub>SD</sub>     | _     | 0.8  | 1.2 | V    | $V_{GS} = 0V, I_{S} = 115mA$  |
| DYNAMIC CHARACTERISTICS (Note 9)         | •                   |       |      |     |      |   |
| Input Capacitance                        | Ciss                |       | 22.0 |     |      |   |
| Output Capacitance                       | Coss                | _     | 3.2  |     | pF   | $V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz$                                 |
| Reverse Transfer Capacitance             | C <sub>rss</sub>    | _     | 2.0  |     |      |   |
| Gate Resistance                          | R <sub>G</sub>      | _     | 79.9 | _   | Ω    | $V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$                                  |
| Total Gate Charge V <sub>GS</sub> = 10V  | Qg                  | —     | 0.87 |     |      |   |
| Total Gate Charge V <sub>GS</sub> = 4.5V | Qg                  | _     | 0.43 |     | nC   | $V_{GS} = 10V, V_{DS} = 30V,$   |
| Gate-Source Charge                       | Qgs                 | _     | 0.11 |     | no   | I <sub>D</sub> = 150mA  |
| Gate-Drain Charge                        | Q <sub>gd</sub>     |       | 0.11 |     |      |   |
| Turn-On Delay Time                       | t <sub>D(on)</sub>  |       | 2.7  |     |      |   |
| Turn-On Rise Time                        | tr                  |       | 2.8  |     | nS   | V <sub>DD</sub> = 30V, I <sub>D</sub> = 0.115A, V <sub>GEN</sub> = 10V, |
| Turn-Off Delay Time                      | t <sub>D(off)</sub> | —     | 12.6 |     | 15   | $R_{GEN} = 25\Omega$  |
| Turn-Off Fall Time                       | tf                  |       | 7.3  |     |      |   |

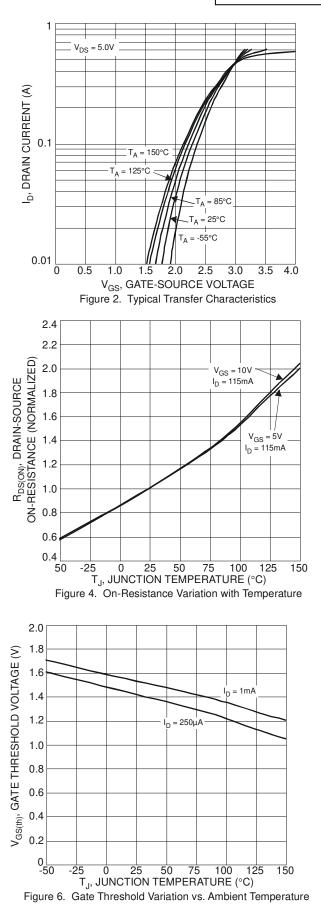
Notes:

8. Short duration pulse test used to minimize self-heating effect.
9. Guaranteed by design. Not subject to production testing.



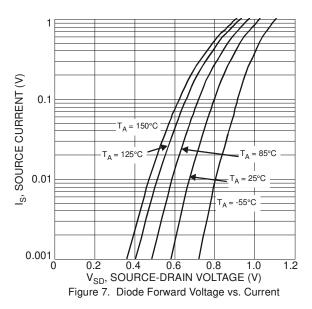
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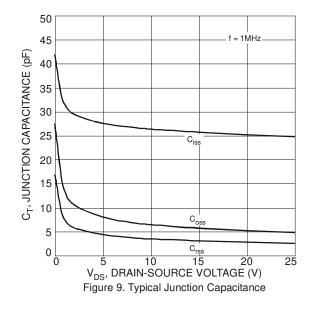


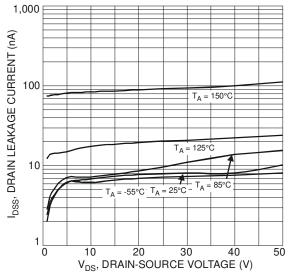


DMN65D8LQ Document number: DS38179 Rev. 1 - 2

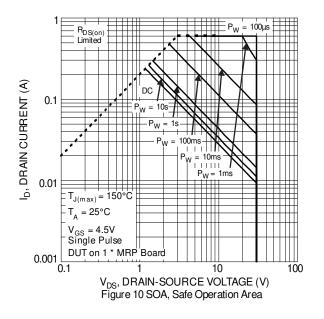




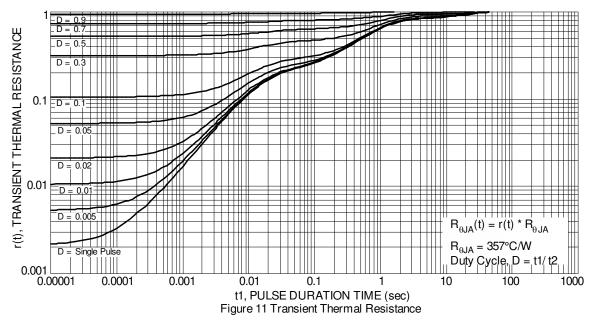










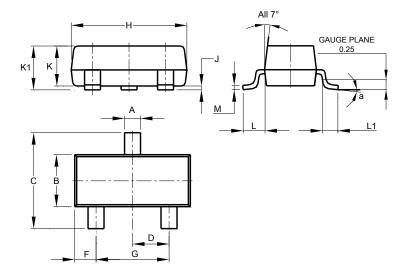




# Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

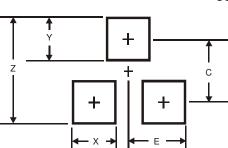
SOT23



| SOT23 |        |         |       |  |  |  |  |
|-------|--------|---------|-------|--|--|--|--|
| Dim   | Min    | Max     | Тур   |  |  |  |  |
| Α     | 0.37   | 0.51    | 0.40  |  |  |  |  |
| В     | 1.20   | 1.40    | 1.30  |  |  |  |  |
| С     | 2.30   | 2.50    | 2.40  |  |  |  |  |
| D     | 0.89   | 1.03    | 0.915 |  |  |  |  |
| F     | 0.45   | 0.60    | 0.535 |  |  |  |  |
| G     | 1.78   | 2.05    | 1.83  |  |  |  |  |
| Н     | 2.80   | 3.00    | 2.90  |  |  |  |  |
| J     | 0.013  | 0.10    | 0.05  |  |  |  |  |
| К     | 0.890  | 1.00    | 0.975 |  |  |  |  |
| K1    | 0.903  | 1.10    | 1.025 |  |  |  |  |
| L     | 0.45   | 0.61    | 0.55  |  |  |  |  |
| L1    | 0.25   | 0.55    | 0.40  |  |  |  |  |
| М     | 0.085  | 0.150   | 0.110 |  |  |  |  |
| а     |        | 8°      |       |  |  |  |  |
| All   | Dimens | ions in | mm    |  |  |  |  |

# Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



SOT23

| Dimensions | Value (in mm) |
|------------|---------------|
| Z          | 2.9           |
| Х          | 0.8           |
| Y          | 0.9           |
| С          | 2.0           |
| E          | 1.35          |



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